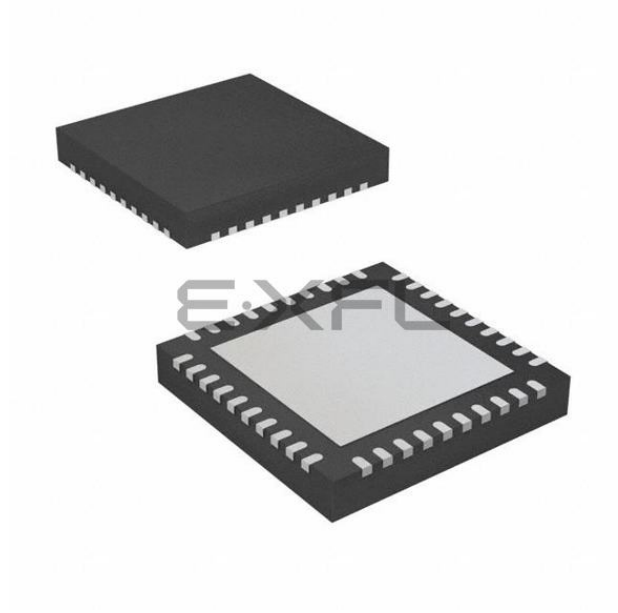

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Details	
Product Status	Active
Core Processor	PIC
Core Size	8-Bit
Speed	32MHz
Connectivity	I²C, LINbus, SPI, UART/USART
Peripherals	Brown-out Detect/Reset, POR, PWM, WDT
Number of I/O	36
Program Memory Size	14KB (8K x 14)
Program Memory Type	FLASH
EEPROM Size	224 x 8
RAM Size	1K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 3.6V
Data Converters	A/D 35x10b; D/A 1x5b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	40-UFQFN Exposed Pad
Supplier Device Package	40-UQFN (5x5)
Purchase URL	https://www.e-xfl.com/product-detail/microchip-technology/pic16lf15375t-i-mv

TABLE 4: 40/44-PIN ALLOCATION TABLE (PIC16(L)F15375, PIC16(L)F15376) (CONTINUED)

I/O(2)	40-Pin PDIP	40-Pin UQFN	44-Pin QFN	44-Pin TQFP	ADC	Reference	Comparator	NCO	DAC	Timers	CCP	PWM	CWG	MSSP	ZCD	EUSART	CLC	CLKR	Interrupt	Pull-up	Basic
RC3	18	33	37	37	ANC3	—	—	—	—	T2IN(1)	—	—	—	SCL1 SCK1(1,4)	—	—	—	—	IOCC3	Y	—
RC4	23	38	42	42	ANC4	—	—	—	—	—	—	—	—	SDA1 SDI1(1,4)	—	—	—	—	IOCC4	Y	—
RC5	24	39	43	43	ANC5	—	—	—	—	—	—	—	—	—	—	—	—	—	IOCC5	Y	—
RC6	25	40	44	44	ANC6	—	—	—	—	—	—	—	—	—	—	TX1 CK1(1)	—	—	IOCC6	Y	—
RC7	26	1	1	1	ANC7	—	—	—	—	—	—	—	—	—	—	RX1 DT1(1)	—	—	IOCC7	Y	—
RD0	19	34	38	38	AND0	—	—	—	—	—	—	—	—	SCK2, SCL2(1,4)	—	—	—	—	—	—	—
RD1	20	35	39	39	AND1	—	—	—	—	—	—	—	—	SDA2, SDI2(1,4)	—	—	—	—	—	—	—
RD2	21	36	40	40	AND2	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—
RD3	22	37	41	41	AND3	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—
RD4	27	2	2	2	AND4	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—
RD5	28	3	3	3	AND5	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—
RD6	29	4	4	4	AND6	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—
RD7	30	5	5	5	AND7	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—
RE0	8	23	25	25	ANE0	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—
RE1	9	24	26	26	ANE1	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—
RE2	10	25	27	27	ANE2	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—
RE3	1	16	18	18	—	—	—	—	—	—	—	—	—	—	—	—	—	—	IOCE3	Y	$\overline{MCLR}$ VPP
VDD	11	26	7	7	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	VDD
VDD	32	7	28	28	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	VDD
VSS	12	27	6	6	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	VSS
VSS	31	6	30	29	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	—	VSS

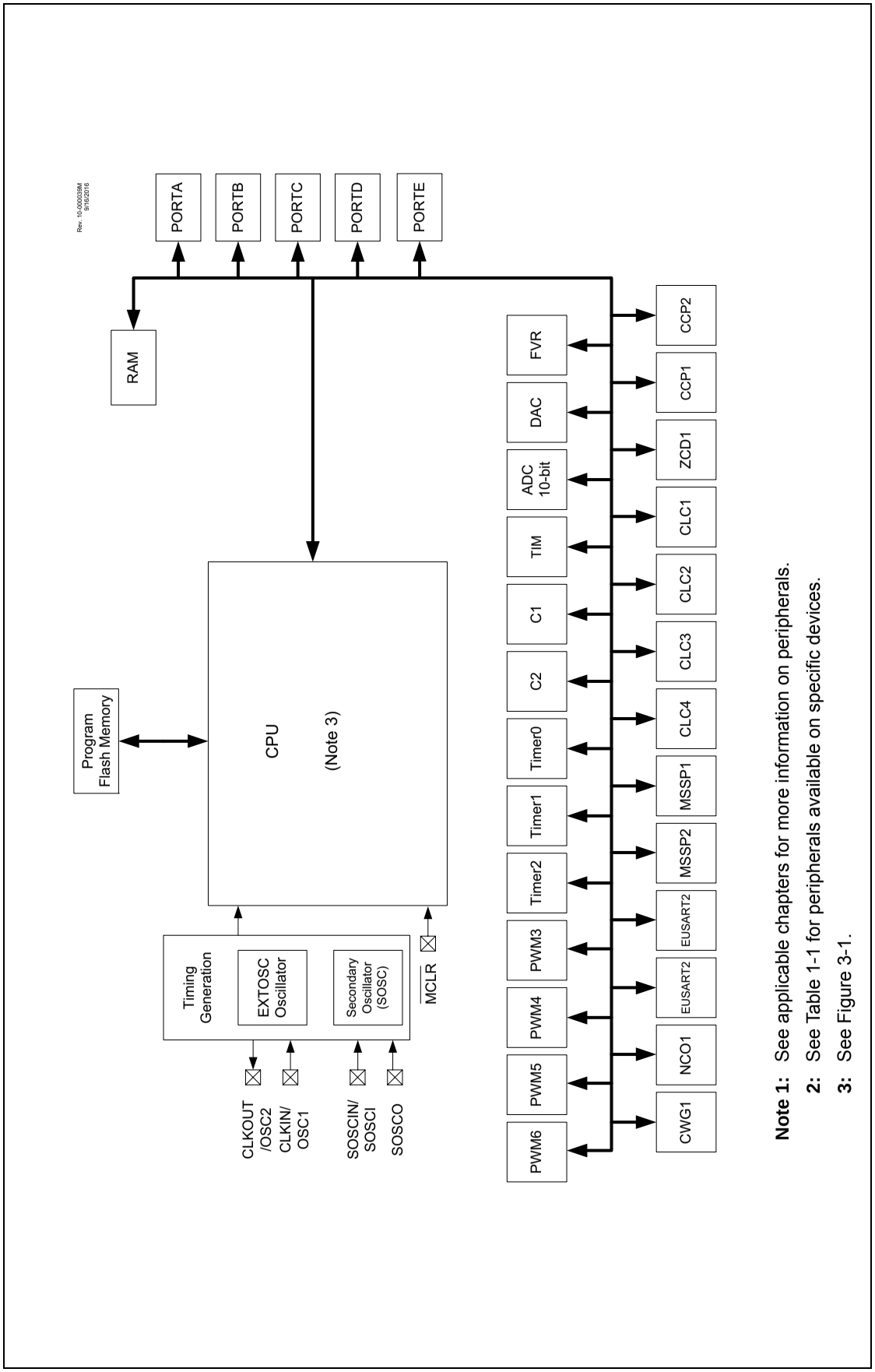
Note 1: This is a PPS re-mappable input signal. The input function may be moved from the default location shown to one of several other PORTx pins.

2: All digital output signals shown in this row are PPS remappable. These signals may be mapped to output onto one of several PORTx pin options.

3: This is a bidirectional signal. For normal module operation, the firmware should map this signal to the same pin in both the PPS input and PPS output registers.

4: These pins are configured for I^2C logic levels. PPS assignments to the other pins will operate, but input logic levels will be standard TTL/ST as selected by the INLVL register, instead of the I^2C specific or SMBUS input buffer thresholds.

FIGURE 1-2: PIC16(L)F15375/76 BLOCK DIAGRAM



Note 1: See applicable chapters for more information on peripherals.

2: See Table 1-1 for peripherals available on specific devices.

3: See Figure 3-1.

TABLE 1-4: PIC16(L)F15385/86 PINOUT DESCRIPTION (CONTINUED)

Name	Function	Input Type	Output Type	Description
RF5/ANF5	RF5	TTL/ST	CMOS/OD	General purpose I/O.
	ANF5	AN	—	ADC Channel D0 input.
RF6/ANF6	RF6	TTL/ST	CMOS/OD	General purpose I/O.
	ANF6	AN	—	ADC Channel D0 input.
RF7/ANF7	RF5	TTL/ST	CMOS/OD	General purpose I/O.
	ANF5	AN	—	ADC Channel D0 input.
VDD	VDD	Power	—	Positive supply voltage input.
VSS	VSS	Power	—	Ground reference.

Legend: AN = Analog input or output CMOS = CMOS compatible input or output OD = Open-Drain
TTL = TTL compatible input ST = Schmitt Trigger input with CMOS levels I^2C = Schmitt Trigger input with I^2C
HV = High Voltage XTAL = Crystal levels

Note 1: This is a PPS remappable input signal. The input function may be moved from the default location shown to one of several other PORTx pins. Refer to Table 15-4 for details on which PORT pins may be used for this signal.

2: All output signals shown in this row are PPS remappable. These signals may be mapped to output onto one of several PORTx pin options as described in Table 15-5, Table 15-6 and Table 15-7.

3: This is a bidirectional signal. For normal module operation, the firmware should map this signal to the same pin in both the PPS input and PPS output registers.

4: These pins are configured for I^2C logic levels. The SCLx/SDAx signals may be assigned to any of the RB1/RB2/RC3/RC4 pins. PPS assignments to the other pins (e.g., RA5) will operate, but input logic levels will be standard TTL/ST, as selected by the INLVL register, instead of the I^2C specific or SMBus input buffer thresholds.

TABLE 4-6: PIC16(L)F15356/75/76/85/86 MEMORY MAP, BANKS 16-23

	BANK 16		BANK 17		BANK 18		BANK 19		BANK 20		BANK 21		BANK 22		BANK 23
800h	Core Register (Table 4-3)	880h	Core Register (Table 4-3)	900h	Core Register (Table 4-3)	980h	Core Register (Table 4-3)	A00h	Core Register (Table 4-3)	A80h	Core Register (Table 4-3)	B00h	Core Register (Table 4-3)	B80h	Core Register (Table 4-3)
80Bh		88Bh		90Bh		98Bh		A0Bh		A8Bh		B0Bh		B8Bh	
80Ch	WDTCON0	88Ch	CPUDOZE	90Ch	FVRCON	98Ch	—	A0Ch	—	A8Ch	—	B0Ch	—	B8Ch	—
80Dh	WDTCON1	88Dh	OSCCON1	90Dh	—	98Dh	—	A0Dh	—	A8Dh	—	B0Dh	—	B8Dh	—
80Eh	WDTL	88Eh	OSCCON2	90Eh	DAC1CON0	98Eh	—	A0Eh	—	A8Eh	—	B0Eh	—	B8Eh	—
80Fh	WDTH	88Fh	OSCCON3	90Fh	DAC1CON1	98Fh	CMOUT	A0Fh	—	A8Fh	—	B0Fh	—	B8Fh	—
810h	WDTU	890h	OSCSTAT1	910h	—	990h	CM1CON0	A10h	—	A90h	—	B10h	—	B90h	—
811h	BORCON	891h	OSCEN	911h	—	991h	CM1CON1	A11h	—	A91h	—	B11h	—	B91h	—
812h	VREGCON(2)	892h	OSCTUNE	912h	—	992h	CM1NCH	A12h	—	A92h	—	B12h	—	B92h	—
813h	PCON0	893h	OSCFRQ	913h	—	993h	CM1PCH	A13h	—	A93h	—	B13h	—	B93h	—
814h	PCON1	894h	—	914h	—	994h	CM2CON0	A14h	—	A94h	—	B14h	—	B94h	—
815h	—	895h	CLKRCON	915h	—	995h	CM2CON1	A15h	—	A95h	—	B15h	—	B95h	—
816h	—	896h	CLKCLK	916h	—	996h	CM2NCH	A16h	—	A96h	—	B16h	—	B96h	—
817h	—	897h	—	917h	—	997h	CM2PCH	A17h	—	A97h	—	B17h	—	B97h	—
818h	—	898h	—	918h	—	998h	—	A18h	—	A98h	—	B18h	—	B98h	—
819h	—	899h	—	919h	—	999h	—	A19h	RC2REG	A99h	—	B19h	—	B99h	—
81Ah	NVMADRL	89Ah	—	91Ah	—	99Ah	—	A1Ah	TX2REG	A9Ah	—	B1Ah	—	B9Ah	—
81Bh	NVMADRH	89Bh	—	91Bh	—	99Bh	—	A1Bh	SP2BRGL	A9Bh	—	B1Bh	—	B9Bh	—
81Ch	NVMDATL	89Ch	—	91Ch	—	99Ch	—	A1Ch	SP2BRGH	A9Ch	—	B1Ch	—	B9Ch	—
81Dh	NVMDATH	89Dh	—	91Dh	—	99Dh	—	A1Dh	RC2STA	A9Dh	—	B1Dh	—	B9Dh	—
81Eh	NVMCON1	89Eh	—	91Eh	—	99Eh	—	A1Eh	TX2STA	A9Eh	—	B1Eh	—	B9Eh	—
81Fh	NVMCON2	89Fh	—	91Fh	ZCDCON	99Fh	—	A1Fh	BAUD2CON	A9Fh	—	B1Fh	—	B9Fh	—
820h	General Purpose Register 80 Bytes(3)	8A0h	General Purpose Register 80 Bytes(3)	920h	General Purpose Register 80 Bytes(3)	9A0h	General Purpose Register 80 Bytes(3)	A20h	General Purpose Register 80 Bytes(3)	AA0h	General Purpose Register 80 Bytes(3)	B20h	General Purpose Register 80 Bytes(3)	BA0h	General Purpose Register 80 Bytes(3)
86Fh		8EFh		96Fh		9EFh		A6Fh		AEFh		B6Fh		BEFh	
870h	Common RAM Accesses 70h-7Fh	8F0h	Common RAM Accesses 70h-7Fh	970h	Common RAM Accesses 70h-7Fh	9F0h	Common RAM Accesses 70h-7Fh	A70h	Common RAM Accesses 70h-7Fh	AF0h	Common RAM Accesses 70h-7Fh	B70h	Common RAM Accesses 70h-7Fh	BF0h	Common RAM Accesses 70h-7Fh
87Fh		8FFh		97Fh		9FFh		A7Fh		AFFh		B7Fh		BFFh	

Note 1: Unimplemented locations read as '0'.
2: Register not implemented on LF devices.
3: Present only in PIC16(L)F15356/76/86.

TABLE 4-11: SPECIAL FUNCTION REGISTER SUMMARY BANKS 0-63 (CONTINUED)

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on: MCLR
Bank 7											
CPU CORE REGISTERS; see Table 4-3 for specifics											
38Ch	PWM6DCL	DC<1:0>		—	—	—	—	—	—	xx-- ----	uu-- ----
38Dh	PWM6DCH	DC<9:0>								xxxx xxxx	uuuu uuuu
38Eh	PWM6CON	EN	—	OUT	POL	—	—	—	—	0-00 ----	0-00 ----
38Fh — 39Fh	—	Unimplemented								—	—

Legend: x = unknown, u = unchanged, q = depends on condition, - = unimplemented, read as '0', r = reserved. Shaded locations unimplemented, read as '0'.

TABLE 4-11: SPECIAL FUNCTION REGISTER SUMMARY BANKS 0-63 (CONTINUED)

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on: MCLR
Bank 12											
CPU CORE REGISTERS; see Table 4-3 for specifics											
60Ch	CWG1CLKCON	—	—	—	—	—	—	—	CS	---- ---0	---- ---0
60Dh	CWG1DAT	—	—	—	—	DAT<3:0>				---- 0000	---- 0000
60Eh	CWG1DBR	—	—	DBR<5:0>						--00 0000	--00 0000
60Fh	CWG1DBF	—	—	DBF<5:0>						--00 0000	--00 0000
610h	CWG1CON0	EN	LD	—	—	—	MODE<2:0>			00-- -000	00-- -000
611h	CWG1CON1	—	—	IN	—	POLD	POLC	POLB	POLA	--x- 0000	--u- 0000
612h	CWG1AS0	SHUTDOWN	REN	LSBD<2:0>		LSAC<2:0>		—	—	0001 01--	0001 01--
613h	CWG1AS1	—	—	—	AS4E	AS3E	AS2E	AS1E	AS0E	---0 0000	---u 0000
614h	CWG1STR	OVRD	OVRC	OVRB	OVRA	STRD	STRC	STRB	STRA	0000 0000	0000 0000
615h — 61Fh	—	Unimplemented								—	—

Legend: x = unknown, u = unchanged, q = depends on condition, - = unimplemented, read as '0', r = reserved. Shaded locations unimplemented, read as '0'.

TABLE 4-11: SPECIAL FUNCTION REGISTER SUMMARY BANKS 0-63 (CONTINUED)

Address	Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Value on: POR, BOR	Value on: MCLR
Bank 15											
CPU CORE REGISTERS; see Table 4-3 for specifics											
78Ch — 795h	—	Unimplemented								—	—
796h	PMD0	SYSCMD	FVRMD	—	—	—	NVMMD	CLKRMD	IOCMD	00-- -000	00-- -000
797h	PMD1	NCO1MD	—	—	—	—	TMR2MD	TMR1MD	TMR0MD	0--- -000	0--- -000
798h	PMD2	—	DAC1MD	ADCMD	—	—	CMP2MD	CMP1MD	ZCDMD	-00- -000	-00- -000
799h	PMD3	—	—	PWM6MD	PWM5MD	PWM4MD	PWM3MD	CCP2MD	CCP1MD	--00 0000	--00 0000
79Ah	PMD4	UART2MD	UART1MD	MSSP2MD	MSSP1MD	—	—	—	CWG1MD	0000 ---0	0000 ---0
79Bh	PMD5	—	—	—	CLC4MD	CLC3MD	CLC2MD	CLC1MD	—	---0 000-	---0 000-
79Ch	—	Unimplemented								—	—
79Dh	—	Unimplemented								—	—
79Eh	—	Unimplemented								—	—
79Fh	—	Unimplemented								—	—

Legend: x = unknown, u = unchanged, q = depends on condition, - = unimplemented, read as '0', r = reserved. Shaded locations unimplemented, read as '0'.

REGISTER 10-14: PIR4: PERIPHERAL INTERRUPT REQUEST REGISTER 4

U-0	U-0	U-0	U-0	U-0	U-0	R/W/HS-0/0	R/W/HS-0/0
—	—	—	—	—	—	TMR2IF	TMR1IF
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	HS = Hardware set

bit 7-2 **Unimplemented:** Read as ‘0’

bit 1 **TRM2IF:** Timer2 Interrupt Flag bit
1 = The TMR2 postscaler overflowed, or in 1:1 mode, a TMR2 to PR2 match occurred (must be cleared in software)
0 = No TMR2 event has occurred

bit 0 **TRM1IF:** Timer1 Overflow Interrupt Flag bit
1 = Timer1 overflow occurred (must be cleared in software)
0 = No Timer1 overflow occurred

Note: Interrupt flag bits are set when an interrupt condition occurs, regardless of the state of its corresponding enable bit or the Global Enable bit, GIE, of the INTCON register. User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt.

REGISTER 10-16: PIR6: PERIPHERAL INTERRUPT REQUEST REGISTER 6

U-0	U-0	U-0	U-0	U-0	U-0	R/W/HS-0/0	R/W/HS-0/0
—	—	—	—	—	—	CCP2IF	CCP1IF
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	HS = Hardware set

bit 7-2 **Unimplemented:** Read as '0'

bit 1 **CCP2IF:** CCP2 Interrupt Flag bit

Value	CCPM Mode		
	Capture	Compare	PWM
1	Capture occurred (must be cleared in software)	Compare match occurred (must be cleared in software)	Output trailing edge occurred (must be cleared in software)
0	Capture did not occur	Compare match did not occur	Output trailing edge did not occur

bit 0 **CCP1IF:** CCP1 Interrupt Flag bit

Value	CCPM Mode		
	Capture	Compare	PWM
1	Capture occurred (must be cleared in software)	Compare match occurred (must be cleared in software)	Output trailing edge occurred (must be cleared in software)
0	Capture did not occur	Compare match did not occur	Output trailing edge did not occur

Note: Interrupt flag bits are set when an interrupt condition occurs, regardless of the state of its corresponding enable bit or the Global Enable bit, GIE, of the INTCON register. User software should ensure the appropriate interrupt flag bits are clear prior to enabling an interrupt.

13.0 NONVOLATILE MEMORY (NVM) CONTROL

NVM consists of the Program Flash Memory (PFM).

NVM is accessible by using both the FSR and INDF registers, or through the NVMREG register interface.

The write time is controlled by an on-chip timer. The write/erase voltages are generated by an on-chip charge pump rated to operate over the operating voltage range of the device.

NVM can be protected in two ways; by either code protection or write protection.

Code protection ($\overline{CP}$ bit in Configuration Word 5) disables access, reading and writing, to the PFM via external device programmers. Code protection does not affect the self-write and erase functionality. Code protection can only be Reset by a device programmer performing a Bulk Erase to the device, clearing all nonvolatile memory, Configuration bits, and User IDs.

Write protection prohibits self-write and erase to a portion or all of the PFM, as defined by the WRT<1:0> bits of Configuration Word 4. Write protection does not affect a device programmer's ability to read, write, or erase the device.

13.1 Program Flash Memory (PFM)

PFM consists of an array of 14-bit words as user memory, with additional words for User ID information, Configuration words, and interrupt vectors. PFM provides storage locations for:

- User program instructions
- User defined data

PFM data can be read and/or written to through:

- CPU instruction fetch (read-only)
- FSR/INDF indirect access (read-only) (**Section 13.2 "FSR and INDF Access"**)
- NVMREG access (**Section 13.3 "NVMREG Access"**
- In-Circuit Serial Programming™ (ICSP™)

Read operations return a single word of memory. When write and erase operations are done on a row basis, the row size is defined in Table 13-1. PFM will erase to a logic '1' and program to a logic '0'.

TABLE 13-1: FLASH MEMORY ORGANIZATION BY DEVICE

Device	Row Erase (words)	Write Latches (words)	Total Program Flash (words)
PIC16(L)F15356	32	32	16K
PIC16(L)F15375/85			8K
PIC16(L)F15376/86			16K

It is important to understand the PFM memory structure for erase and programming operations. PFM is arranged in rows. A row consists of 32 14-bit program memory words. A row is the minimum size that can be erased by user software.

All or a portion of this row can be programmed. Data to be written into the program memory row is written to 14-bit wide data write latches. These latches are not directly accessible, but may be loaded via sequential writes to the NVMDATH:NVMDATL register pair.

Note:	To modify only a portion of a previously programmed row, the contents of the entire row must be read. Then, the new data and retained data can be written into the write latches to reprogram the row of PFM. However, any unprogrammed locations can be written without first erasing the row. In this case, it is not necessary to save and rewrite the other previously programmed locations

13.1.1 PROGRAM MEMORY VOLTAGES

The PFM is readable and writable during normal operation over the full V_{DD} range.

13.1.1.1 Programming Externally

The program memory cell and control logic support write and Bulk Erase operations down to the minimum device operating voltage. Special BOR operation is enabled during Bulk Erase (**Section 8.2.4 "BOR is always OFF"**).

13.1.1.2 Self-programming

The program memory cell and control logic will support write and row erase operations across the entire V_{DD} range. Bulk Erase is not available when self-programming.

EXAMPLE 13-1: PROGRAM MEMORY READ

```
* This code block will read 1 word of program
* memory at the memory address:
    PROG_ADDR_HI : PROG_ADDR_LO
*   data will be returned in the variables;
*   PROG_DATA_HI, PROG_DATA_LO

    BANKSEL  NVMADRL          ; Select Bank for NVMCON registers
    MOVLW    PROG_ADDR_LO     ;
    MOVWF    NVMADRL          ; Store LSB of address
    MOVLW    PROG_ADDR_HI     ;
    MOVWF    NVMADRH          ; Store MSB of address

    BCF      NVMCON1,NVMREGS  ; Do not select Configuration Space
    BSF      NVMCON1,RD       ; Initiate read

    MOVF     NVMDATL,W        ; Get LSB of word
    MOVWF    PROG_DATA_LO     ; Store in user location
    MOVF     NVMDATH,W        ; Get MSB of word
    MOVWF    PROG_DATA_HI     ; Store in user location
```

REGISTER 13-5: NVMCON1: NONVOLATILE MEMORY CONTROL 1 REGISTER

U-0	R/W-0/0	R/W-0/0	R/W/HC-0/0	R/W/HC-x/q	R/W-0/0	R/S/HC-0/0	R/S/HC-0/0
—	NVMREGS	LWLO	FREE	WRERR(1,2,3)	WREN	WR(4,5,6)	RD
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as '0'
S = Bit can only be set	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
'1' = Bit is set	'0' = Bit is cleared	HC = Bit is cleared by hardware

bit 7 **Unimplemented:** Read as '0'

bit 6 **NVMREGS:** Configuration Select bit
1 = Access DIA, DCI, Configuration, User ID and Device ID Registers
0 = Access PFM

bit 5 **LWLO:** Load Write Latches Only bit
When FREE = 0:
1 = The next WR command updates the write latch for this word within the row; no memory operation is initiated.
0 = The next WR command writes data or erases
Otherwise: The bit is ignored

bit 4 **FREE:** PFM Erase Enable bit
When NVMREGS:NVMADR points to a PFM location:
1 = Performs an erase operation with the next WR command; the 32-word pseudo-row containing the indicated address is erased (to all 1s) to prepare for writing.
0 = All erase operations have completed normally

bit 3 **WRERR:** Program/Erase Error Flag bit(1,2,3)
This bit is normally set by hardware.
1 = A write operation was interrupted by a Reset, interrupted unlock sequence, or WR was written to one while NVMADR points to a write-protected address.
0 = The program or erase operation completed normally

bit 2 **WREN:** Program/Erase Enable bit
1 = Allows program/erase cycles
0 = Inhibits programming/erasing of program Flash

bit 1 **WR:** Write Control bit(4,5,6)
When NVMREG:NVMADR points to a PFM location:
1 = Initiates the operation indicated by Table 13-4
0 = NVM program/erase operation is complete and inactive.

bit 0 **RD:** Read Control bit(7)
1 = Initiates a read at address = NVMADR1, and loads data to NVMDAT Read takes one instruction cycle and the bit is cleared when the operation is complete. The bit can only be set (not cleared) in software.
0 = NVM read operation is complete and inactive

Note 1: Bit is undefined while WR = 1.
2: Bit must be cleared by software; hardware will not clear this bit.
3: Bit may be written to '1' by software in order to implement test sequences.
4: This bit can only be set by following the unlock sequence of **Section 13.3.2 "NVM Unlock Sequence"**.
5: Operations are self-timed, and the WR bit is cleared by hardware when complete.
6: Once a write operation is initiated, setting this bit to zero will have no effect.

24.7 Operation During Sleep

The ZCD current sources and interrupts are unaffected by Sleep.

24.8 Effects of a Reset

The ZCD circuit can be configured to default to the active or inactive state on Power-on-Reset (POR). When the ZCDDIS Configuration bit is cleared, the ZCD circuit will be active at POR. When the $\overline{ZCD}$ Configuration bit is set, the EN bit of the ZCDxCON register must be set to enable the ZCD module.

26.1 Timer1 Operation

The Timer1 modules are 16-bit incrementing counters which are accessed through the TMR1H:TMR1L register pairs. Writes to TMR1H or TMR1L directly update the counter.

When used with an internal clock source, the module is a timer and increments on every instruction cycle. When used with an external clock source, the module can be used as either a timer or counter and increments on every selected edge of the external source.

The timer is enabled by configuring the TMR1ON and GE bits in the T1CON and T1GCON registers, respectively. Table 26-1 displays the Timer1 enable selections.

TABLE 26-1: TIMER1 ENABLE SELECTIONS

TMR1ON	TMR1GE	Timer1 Operation
1	1	Count Enabled
1	0	Always On
0	1	Off
0	0	Off

26.2 Clock Source Selection

The T1CLK register is used to select the clock source for the timer. Register 26-3 shows the possible clock sources that may be selected to make the timer increment.

26.2.1 INTERNAL CLOCK SOURCE

When the internal clock source FOSC is selected, the TMR1H:TMR1L register pair will increment on multiples of FOSC as determined by the respective Timer1 prescaler.

When the FOSC internal clock source is selected, the timer register value will increment by four counts every instruction clock cycle. Due to this condition, a 2 LSB error in resolution will occur when reading the TMR1H:TMR1L value. To utilize the full resolution of the timer in this mode, an asynchronous input signal must be used to gate the timer clock input.

Out of the total timer gate signal sources, the following subset of sources can be asynchronous and may be useful for this purpose:

- CLC4 output
- CLC3 output
- CLC2 output
- CLC1 output
- Zero-Cross Detect output
- Comparator2 output
- Comparator1 output
- TxG PPS remappable input pin

26.2.2 EXTERNAL CLOCK SOURCE

When the timer is enabled and the external clock input source (ex: T1CKI PPS remappable input) is selected as the clock source, the timer will increment on the rising edge of the external clock input.

When using an external clock source, the timer can be configured to run synchronously or asynchronously, as described in **Section 26.5 "Timer Operation in Asynchronous Counter Mode"**.

When used as a timer with a clock oscillator, an external 32.768 kHz crystal can be used connected to the SOSCI/SOSCO pins.

Note: In Counter mode, a falling edge must be registered by the counter prior to the first incrementing rising edge after any one or more of the following conditions:

- The timer is first enabled after POR
- Firmware writes to TMR1H or TMR1L
- The timer is disabled
- The timer is re-enabled (e.g., TMR1ON-->1) when the T1CKI signal is currently logic low.

27.5.10 LEVEL-TRIGGERED HARDWARE LIMIT ONE-SHOT MODES

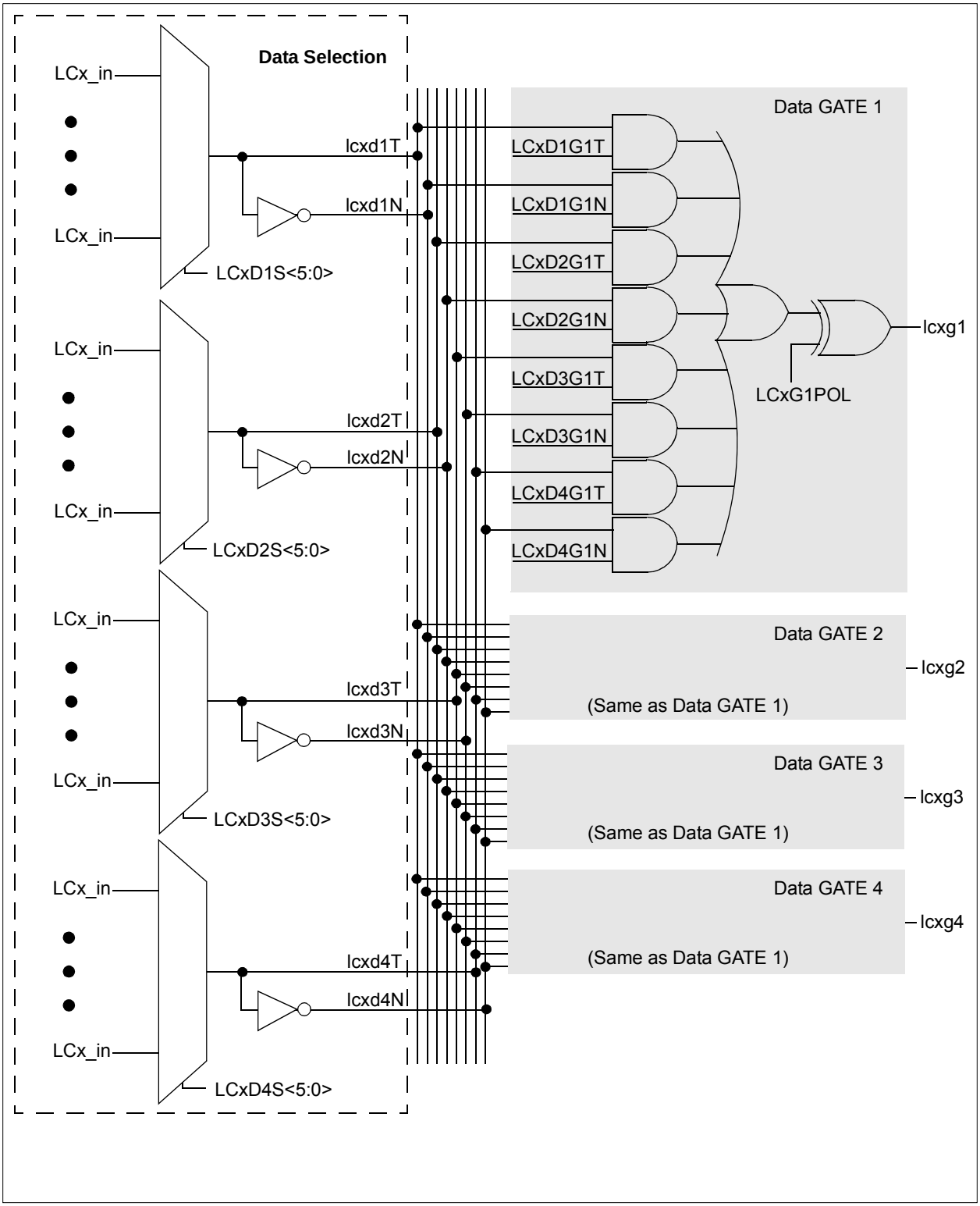
The Level-Triggered Hardware Limit One-Shot modes hold the timer in Reset on an external Reset level and start counting when both the ON bit is set and the external signal is not at the Reset level. If one of either the external signal is not in Reset or the ON bit is set then the other signal being set/made active will start the timer. Reset levels are selected as follows:

- Low Reset level (MODE<4:0> = `10110`)
- High Reset level (MODE<4:0> = `10111`)

When the timer count matches the PRx period count, the timer is reset and the ON bit is cleared. When the ON bit is cleared by either a PRx match or by software control the timer will stay in Reset until both the ON bit is set and the external signal is not at the Reset level.

When Level-Triggered Hardware Limit One-Shot modes are used in conjunction with the CCP PWM operation the PWM drive goes active with either the external signal edge or the setting of the ON bit, whichever of the two starts the timer.

FIGURE 31-2: INPUT DATA SELECTION AND GATING



33.3.5 RECEIVING A BREAK CHARACTER

The Enhanced EUSART module can receive a Break character in two ways.

The first method to detect a Break character uses the FERR bit of the RCxSTA register and the received data as indicated by RCxREG. The Baud Rate Generator is assumed to have been initialized to the expected baud rate.

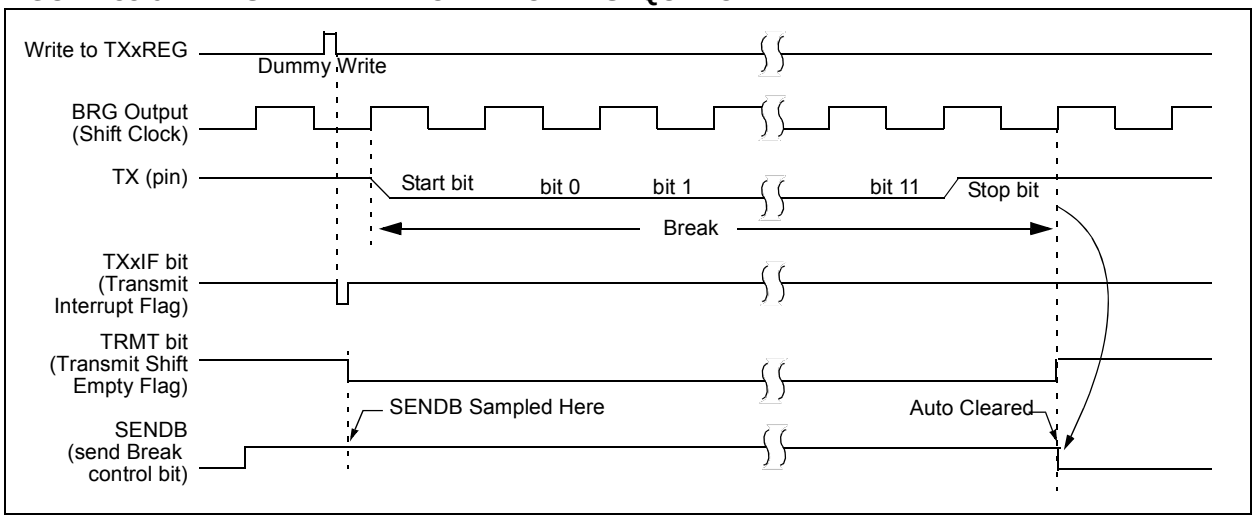
A Break character has been received when:

- RXxIF bit is set
- FERR bit is set
- RCxREG = 00h

The second method uses the Auto-Wake-up feature described in **Section 33.3.3 "Auto-Wake-up on Break"**. By enabling this feature, the EUSART will sample the next two transitions on RX/DT, cause an RXxIF interrupt, and receive the next data byte followed by another interrupt.

Note that following a Break character, the user will typically want to enable the Auto-Baud Detect feature. For both methods, the user can set the ABDEN bit of the BAUDxCON register before placing the EUSART in Sleep mode.

FIGURE 33-9: SEND BREAK CHARACTER SEQUENCE



REGISTER 33-7: SPxBRGH(1, 2): BAUD RATE GENERATOR HIGH REGISTER

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
SPxBRG<15:8>							
bit 7							bit 0

Legend:		
R = Readable bit	W = Writable bit	U = Unimplemented bit, read as ‘0’
u = Bit is unchanged	x = Bit is unknown	-n/n = Value at POR and BOR/Value at all other Resets
‘1’ = Bit is set	‘0’ = Bit is cleared	

bit 7 **SPxBRG<15:8>:** Upper eight bits of the Baud Rate Generator

Note 1: SPxBRGH value is ignored for all modes unless BAUDxCON<BRG16> is active.

2: Writing to SPxBRGH resets the BRG counter.

SLEEP **Enter Sleep mode**

Syntax: [*label*] SLEEP

Operands: None

Operation: 00h → WDT,
0 → WDT prescaler,
1 → $\overline{TO}$,
0 → $\overline{PD}$

Status Affected: $\overline{TO}$, $\overline{PD}$

Description: The power-down Status bit, $\overline{PD}$ is cleared. Time-out Status bit, $\overline{TO}$ is set. Watchdog Timer and its prescaler are cleared.
See **Section 11.2 "Sleep Mode"** for more information.

SUBLW **Subtract W from literal**

Syntax: [*label*] SUBLW k

Operands: 0 ≤ k ≤ 255

Operation: k - (W) → (W)

Status Affected: C, DC, Z

Description: The W register is subtracted (2's complement method) from the 8-bit literal 'k'. The result is placed in the W register.

C = 0	W > k
C = 1	W ≤ k
DC = 0	W<3:0> > k<3:0>
DC = 1	W<3:0> ≤ k<3:0>

SUBWF **Subtract W from f**

Syntax: [*label*] SUBWF f,d

Operands: 0 ≤ f ≤ 127
d ∈ [0,1]

Operation: (f) - (W) → (destination)

Status Affected: C, DC, Z

Description: Subtract (2's complement method) W register from register 'f'. If 'd' is '0', the result is stored in the W register. If 'd' is '1', the result is stored back in register 'f.

C = 0	W > f
C = 1	W ≤ f
DC = 0	W<3:0> > f<3:0>
DC = 1	W<3:0> ≤ f<3:0>

SUBWFB **Subtract W from f with Borrow**

Syntax: SUBWFB f {,d}

Operands: 0 ≤ f ≤ 127
d ∈ [0,1]

Operation: (f) – (W) – ($\overline{B}$) → dest

Status Affected: C, DC, Z

Description: Subtract W and the BORROW flag (CARRY) from register 'f' (2's complement method). If 'd' is '0', the result is stored in W. If 'd' is '1', the result is stored back in register 'f'.

SWAPF **Swap Nibbles in f**

Syntax: [*label*] SWAPF f,d

Operands: 0 ≤ f ≤ 127
d ∈ [0,1]

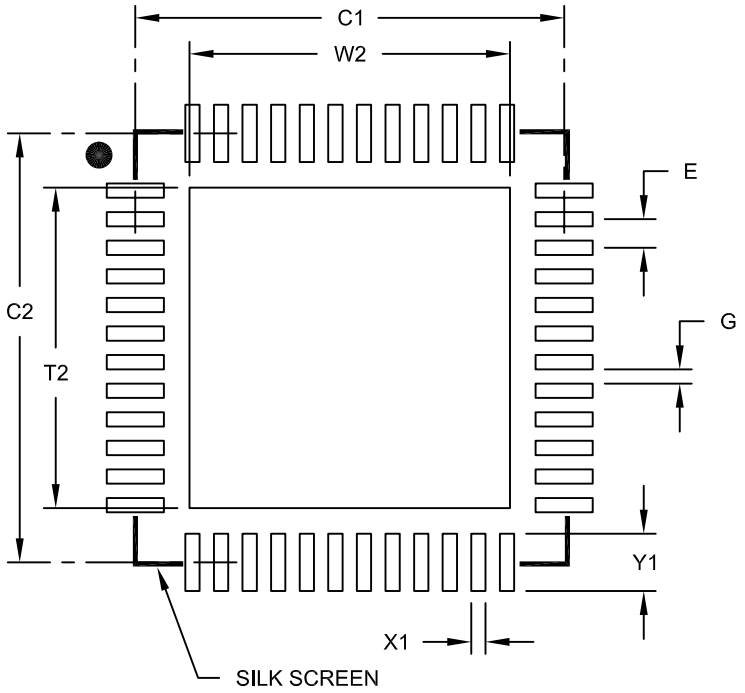
Operation: (f<3:0>) → (destination<7:4>),
(f<7:4>) → (destination<3:0>)

Status Affected: None

Description: The upper and lower nibbles of register 'f' are exchanged. If 'd' is '0', the result is placed in the W register. If 'd' is '1', the result is placed in register 'f'.

48-Lead Ultra Thin Plastic Quad Flat, No Lead Package (MV) - 6x6 mm Body [UQFN]
With 0.40 mm Contact Length

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E		0.40 BSC	
Optional Center Pad Width	W2			4.45
Optional Center Pad Length	T2			4.45
Contact Pad Spacing	C1		6.00	
Contact Pad Spacing	C2		6.00	
Contact Pad Width (X28)	X1			0.20
Contact Pad Length (X28)	Y1			0.80
Distance Between Pads	G	0.20		

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2153A